

### 16-Bit, 1 MSPS/500 kSPS Differential PulSAR ADCs

#### FEATURES

- ▶ High performance
  - ▶ True differential analog input range:  $\pm V_{REF}$ 
    - ▶ 0 V to  $V_{REF}$  with  $V_{REF}$  between 2.5 V and 5 V
  - ▶ Throughput: 1 MSPS/500 kSPS options
    - ▶ Zero latency architecture
  - ▶ 16-bit resolution with no missing codes
  - ▶ INL:  $\pm 0.4$  LSB typical,  $\pm 1$  LSB maximum
  - ▶ Dynamic range: 95.5 dB,  $V_{REF} = 5$  V
  - ▶ SNR: 94 dB at  $f_{IN} = 1$  kHz,  $V_{REF} = 5$  V
  - ▶ THD:  $-118.5$  dB at  $f_{IN} = 1$  kHz,  $V_{REF} = 5$  V
  - ▶ SINAD: 93.5 dB at  $f_{IN} = 1$  kHz,  $V_{REF} = 5$  V
- ▶ Low power dissipation
  - ▶ Single-supply 2.5 V operation with 1.8 V/2.5 V/3 V/5 V logic interface
  - ▶ AD7915: 4 mW at 1 MSPS (VDD only)
    - ▶ 7 mW at 1 MSPS (total)
  - ▶ AD7916: 2 mW at 500 kSPS (VDD only)
    - ▶ 3.7 mW at 500 kSPS (total)
  - ▶ 70  $\mu$ W at 10 kSPS
- ▶ Proprietary serial interface: SPI-/QSPI-/MICROWIRE™-/DSP-compatible<sup>1</sup>
- ▶ 10-lead packages: MSOP and 3 mm  $\times$  3 mm LFCSP
- ▶ Wide operating temperature range:  $-40^{\circ}\text{C}$  to  $+125^{\circ}\text{C}$

#### APPLICATIONS

- ▶ Automated test equipment
- ▶ Data acquisition systems
- ▶ Medical instruments
- ▶ Machine automation

#### TYPICAL APPLICATIONS CIRCUIT

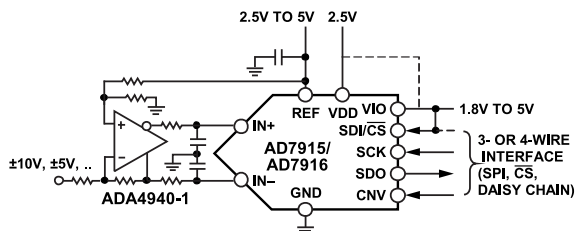


Figure 1.

#### GENERAL DESCRIPTION

The AD7915/AD7916 are 16-bit, successive approximation, analog-to-digital converters (ADCs) that operate from a single power supply, VDD. They contain a low power, high speed, 16-bit sampling ADC and a versatile serial interface port. On the CNV rising edge, the AD7915/AD7916 sample the voltage difference between the IN+ and IN- pins. The voltages on these pins typically swing in opposite phases between 0 V and  $V_{REF}$ . The reference voltage, REF, is applied externally and can be set independent of the supply voltage, VDD. The power consumption of the AD7915/AD7916 scales linearly with throughput.

The AD7915/AD7916 are serial peripheral interface (SPI) compatible, which features the ability, using the SDI input, to daisy-chain several ADCs on a single 3-wire bus. They are compatible with 1.8 V, 2.5 V, 3 V, and 5 V logic using the separate VIO supply.

The AD7915/AD7916 are available in a 10-lead MSOP or a 10-lead LFCSP with operation specified from  $-40^{\circ}\text{C}$  to  $+125^{\circ}\text{C}$ .

Table 1. MSOP, LFCSP 16-/18-/20-Bit Precision Successive Approximation Register (SAR) ADCs and SAR ADC-Based Devices

Type	≤100 kSPS	≤250 kSPS	≤500 kSPS	≤1000 kSPS	≤2000 kSPS	μModule® Data Acquisition Solutions
Differential						
20-Bit			AD4022 <sup>1</sup>	AD4021 <sup>1</sup>	AD4020 <sup>1</sup>	
18-Bit	AD7989-1 <sup>1</sup>	AD7691 <sup>1</sup>	AD4011 <sup>1</sup> , AD7690 <sup>1</sup> , AD7989-5 <sup>1</sup>	AD4007 <sup>1</sup> , AD7982 <sup>1</sup> , AD7984 <sup>1</sup>	AD4003 <sup>1</sup>	
16-Bit	AD7684	AD7687 <sup>1</sup>	AD7688 <sup>1</sup> , AD7693 <sup>1</sup> , AD7916 <sup>1</sup>	AD4005 <sup>1</sup> , AD7915 <sup>1</sup>	AD4001 <sup>1</sup>	
Pseudo-Differential						
18-Bit			AD4010 <sup>1</sup>	AD4006 <sup>1</sup>	AD4002 <sup>1</sup>	
16-Bit	AD7988-1 <sup>1</sup> , AD7680, AD7683	AD7685 <sup>1</sup> , AD7694	AD4008 <sup>1</sup> , AD7988-5 <sup>1</sup> , AD7686 <sup>1</sup>	AD4004 <sup>1</sup> , AD7980 <sup>1</sup> , AD7983 <sup>1</sup>	AD4000 <sup>1</sup>	ADAQ7980, ADAQ7988

<sup>1</sup> Pin for pin compatible.

<sup>1</sup> Protected by U.S. Patent 6,703,961.

#### Rev. B

#### DOCUMENT FEEDBACK

#### TECHNICAL SUPPORT

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**REVISION HISTORY****4/2023—Rev. A to Rev. B**

Updated Outline Dimensions.....	26
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**3/2015—Revision 0: Initial Version**

## SPECIFICATIONS

VDD = 2.5 V, VIO = 1.71 V to 5.5 V, VREF = 5 V, TA = -40°C to +125°C, unless otherwise noted.

Table 2.

Parameter	Test Conditions/Comments	Min	Typ	Max	Unit
RESOLUTION		16			Bits
ANALOG INPUT					
Voltage Range	IN+ – IN–	–VREF		+VREF	V
Absolute Input Voltage	IN+, IN–	–0.1		VREF + 0.1	V
Common-Mode Input Range	IN+, IN–	VREF × 0.475	VREF × 0.5	VREF × 0.525	V
Analog Input Common-Mode Rejection Ratio (CMRR)	fIN = 450 kHz		60		dB
Leakage Current at 25°C	Acquisition phase		1		nA
Input Impedance			See the <a href="#">Analog Inputs</a> section		
ACCURACY					
No Missing Codes		16			Bits
Differential Nonlinearity (DNL) Error	VREF = 5 V	–0.9	±0.4	+0.9	LSB <sup>1</sup>
	VREF = 2.5 V		±0.5		LSB <sup>1</sup>
Integral Nonlinearity (INL) Error	VREF = 5 V	–1	±0.4	+1	LSB <sup>1</sup>
	VREF = 2.5 V		±0.5		LSB <sup>1</sup>
Transition Noise	VREF = 5 V		0.75		LSB <sup>1</sup>
	VREF = 2.5 V		1.2		LSB <sup>1</sup>
Gain Error <sup>2</sup>	TMIN to TMAX	–10	0	+10	LSB <sup>1</sup>
Gain Error Temperature Drift			±0.23		ppm/°C
Zero Error <sup>2</sup>	TMIN to TMAX	–0.5	±0.08	+0.5	mV
Zero Temperature Drift			0.28		ppm/°C
Power Supply Sensitivity	VDD = 2.5 V ± 5%		±0.1		dB
THROUGHPUT					
AD7915 Conversion Rate	VIO > 2.3 V	0		1	MSPS
	VIO ≤ 2.3 V	0		833	kSPS
AD7916 Conversion Rate		0		500	kSPS
Transient Response	Full-scale step			290	ns
AC ACCURACY					
Dynamic Range	VREF = 5 V		95.5		dB <sup>3</sup>
	VREF = 2.5 V		92		dB <sup>3</sup>
Oversampled Dynamic Range <sup>4</sup>	fO = 10 kSPS		113.5		dB <sup>3</sup>
Signal-to-Noise Ratio (SNR)	fIN = 1 kHz, VREF = 5 V	93	94		dB <sup>3</sup>
	fIN = 1 kHz, VREF = 2.5 V	89	91		dB <sup>3</sup>
Spurious-Free Dynamic Range (SFDR)	fIN = 1 kHz		–118		dB <sup>3</sup>
Total Harmonic Distortion (THD)	fIN = 1 kHz		–118.5		dB <sup>3</sup>
Signal-to-Noise-and-Distortion Ratio (SINAD)	fIN = 1 kHz, VREF = 5 V		93.5		dB <sup>3</sup>
	fIN = 1 kHz, VREF = 2.5 V		90.5		dB <sup>3</sup>
REFERENCE					
Voltage Range		2.4		5.1	V
Load Current	VREF = 5 V		330		μA
SAMPLING DYNAMICS					
–3 dB Input Bandwidth			10		MHz
Aperture Delay	VDD = 2.5 V		2		ns

## SPECIFICATIONS

Table 2. (Continued)

Parameter	Test Conditions/Comments	Min	Typ	Max	Unit
DIGITAL INPUTS					
Logic Levels					
$V_{IL}$	$V_{IO} > 3\text{ V}$	-0.3		$+0.3 \times V_{IO}$	V
	$V_{IO} \leq 3\text{ V}$	-0.3		$+0.1 \times V_{IO}$	V
$V_{IH}$	$V_{IO} > 3\text{ V}$	$0.7 \times V_{IO}$		$V_{IO} + 0.3$	V
	$V_{IO} \leq 3\text{ V}$	$0.9 \times V_{IO}$		$V_{IO} + 0.3$	V
$I_{IL}$		-1		+1	$\mu\text{A}$
$I_{IH}$		-1		+1	$\mu\text{A}$
DIGITAL OUTPUTS					
Data Format		Serial, 16 bits, twos complement			
Pipeline Delay		Conversion results available immediately after completed conversion			
$V_{OL}$	$I_{SINK} = 500\text{ }\mu\text{A}$			0.4	V
$V_{OH}$	$I_{SOURCE} = -500\text{ }\mu\text{A}$	$V_{IO} - 0.3$			V
POWER SUPPLIES					
VDD		2.375	2.5	2.625	V
VIO		1.71		5.5	V
Standby Current <sup>5, 6</sup>	$V_{DD}$ and $V_{IO} = 2.5\text{ V}$ , $T_A = 25^\circ\text{C}$		0.35		$\mu\text{A}$
AD7915 Power Dissipation					
Total					
	10 kSPS throughput		70		$\mu\text{W}$
	1 MSPS throughput		7	9	mW
VDD Only	1 MSPS throughput		4		mW
REF Only	1 MSPS throughput		1.7		mW
VIO Only	1 MSPS throughput		1.3		mW
AD7916 Power Dissipation					
Total					
	500 kSPS throughput		3.7	4.5	mW
VDD Only	500 kSPS throughput		2		mW
REF Only	500 kSPS throughput		0.85		mW
VIO Only	500 kSPS throughput		0.85		mW
Energy per Conversion			7.0		nJ/sample
TEMPERATURE RANGE					
Specified Performance	$T_{MIN}$ to $T_{MAX}$	-40		+125	$^\circ\text{C}$

<sup>1</sup> LSB means least significant bit. With the  $\pm 5\text{ V}$  input range, 1 LSB is 152.6  $\mu\text{V}$ .

<sup>2</sup> See the Terminology section. These specifications include full temperature range variation but not the error contribution from the external reference.

<sup>3</sup> All specifications expressed in decibels are referred to a full-scale range (FSR) and tested with an input signal at 0.5 dB below full scale, unless otherwise specified.

<sup>4</sup> Dynamic range is obtained by oversampling the ADC running at a throughput,  $f_S$ , of 1 MSPS followed by post digital filtering with an output word rate of  $f_D$ .

<sup>5</sup> With all digital inputs forced to VIO or ground as required.

<sup>6</sup> During acquisition phase.

## SPECIFICATIONS

## TIMING SPECIFICATIONS

$T_A = -40^{\circ}\text{C}$  to  $+125^{\circ}\text{C}$ ,  $V_{DD} = 2.37\text{ V}$  to  $2.63\text{ V}$ ,  $V_{IO} = 2.3\text{ V}$  to  $5.5\text{ V}$ ,  $C_{\text{LOAD\_SDO}} = 20\text{ pF}$ , unless otherwise noted.

Table 3.

Parameter <sup>1</sup>	Symbol	Min	Typ	Max	Unit
AD7915					
Throughput Rate				1	MSPS
Conversion Time: CNV Rising Edge to Data Available	$t_{\text{CONV}}$	500		710	ns
Acquisition Time	$t_{\text{ACQ}}$	290			ns
Time Between Conversions	$t_{\text{CYC}}$	1			$\mu\text{s}$
AD7916					
Throughput Rate				500	kSPS
Conversion Time: CNV Rising Edge to Data Available	$t_{\text{CONV}}$	0.5		1.6	$\mu\text{s}$
Acquisition Time	$t_{\text{ACQ}}$	400			ns
Time Between Conversions	$t_{\text{CYC}}$	2			$\mu\text{s}$
CNV Pulse Width ( $\overline{\text{CS}}$ Mode)	$t_{\text{CNVH}}$	10			ns
SCK Period ( $\overline{\text{CS}}$ Mode)	$t_{\text{SCK}}$				
VIO Above 4.5 V		10.5			ns
VIO Above 3 V		12			ns
VIO Above 2.7 V		13			ns
VIO Above 2.3 V		15			ns
SCK Period (Chain Mode)	$t_{\text{SCK}}$				
VIO Above 4.5 V		11.5			ns
VIO Above 3 V		13			ns
VIO Above 2.7 V		14			ns
VIO Above 2.3 V		16			ns
SCK Low Time	$t_{\text{SCKL}}$	4.5			ns
SCK High Time	$t_{\text{SCKH}}$	4.5			ns
SCK Falling Edge to Data Remains Valid	$t_{\text{HSDO}}$	3			ns
SCK Falling Edge to Data Valid Delay	$t_{\text{DSDO}}$				
VIO Above 4.5 V				9.5	ns
VIO Above 3 V				11	ns
VIO Above 2.7 V				12	ns
VIO Above 2.3 V				14	ns
CNV or SDI Low to SDO D15 MSB Valid ( $\overline{\text{CS}}$ Mode)	$t_{\text{EN}}$				
VIO Above 3 V				10	ns
VIO Above 2.3 V				15	ns
CNV or SDI High or Last SCK Falling Edge to SDO High Impedance ( $\overline{\text{CS}}$ Mode)	$t_{\text{DIS}}$			20	ns
SDI Valid Setup Time from CNV Rising Edge ( $\overline{\text{CS}}$ Mode)	$t_{\text{SSDICNV}}$	5			ns
SDI Valid Hold Time from CNV Rising Edge ( $\overline{\text{CS}}$ Mode)	$t_{\text{HSDICNV}}$	2			ns
SCK Valid Setup Time from CNV Rising Edge (Chain Mode)	$t_{\text{SSCKCNV}}$	5			ns
SCK Valid Hold Time from CNV Rising Edge (Chain Mode)	$t_{\text{HSCKCNV}}$	5			ns
SDI Valid Setup Time from SCK Falling Edge (Chain Mode)	$t_{\text{SSDISCK}}$	2			ns
SDI Valid Hold Time from SCK Falling Edge (Chain Mode)	$t_{\text{HSDISCK}}$	3			ns
SDI High to SDO High (Chain Mode with Busy Indicator)	$t_{\text{DSDOSDI}}$			15	ns

<sup>1</sup> Timing parameters measured with respect to a falling edge are defined as triggered at x% VIO. Timing parameters measured with respect to a rising edge are defined as triggered at y% VIO. For  $V_{IO} \leq 3\text{ V}$ ,  $x = 90$  and  $y = 10$ . For  $V_{IO} > 3\text{ V}$ ,  $x = 70$  and  $y = 30$ . The minimum  $V_{IH}$  and maximum  $V_{IL}$  are used. See the Digital Inputs Specifications in Table 2.

## SPECIFICATIONS

VDD = 2.37 V to 2.63 V, VIO = 1.71 V to 2.3 V, T<sub>A</sub> = -40°C to +125°C, unless otherwise stated.

Table 4.

Parameter <sup>1</sup>	Symbol	Min	Typ	Max	Unit
AD7915					
Throughput Rate				833	kSPS
Conversion Time: CNV Rising Edge to Data Available	t <sub>CONV</sub>	500		710	ns
Acquisition Time	t <sub>ACQ</sub>	290			ns
Time Between Conversions <sup>2</sup>	t <sub>CYC</sub>	1.2			μs
AD7916					
Throughput Rate				500	kSPS
Conversion Time: CNV Rising Edge to Data Available	t <sub>CONV</sub>	0.5		1.6	μs
Acquisition Time	t <sub>ACQ</sub>	400			ns
Time Between Conversions	t <sub>CYC</sub>	2			μs
CNV Pulse Width ( $\overline{\text{CS}}$ Mode)	t <sub>CNVH</sub>	10			ns
SCK Period ( $\overline{\text{CS}}$ Mode)	t <sub>SCK</sub>	22			ns
SCK Period (Chain Mode)	t <sub>SCK</sub>	23			ns
SCK Low Time	t <sub>SCKL</sub>	6			ns
SCK High Time	t <sub>SCKH</sub>	6			ns
SCK Falling Edge to Data Remains Valid	t <sub>HSDO</sub>	3			ns
SCK Falling Edge to Data Valid Delay	t <sub>DSDO</sub>		14	21	ns
CNV or SDI Low to SDO D15 MSB Valid ( $\overline{\text{CS}}$ Mode)	t <sub>EN</sub>		18	40	ns
CNV or SDI High or Last SCK Falling Edge to SDO High Impedance ( $\overline{\text{CS}}$ Mode)	t <sub>DIS</sub>			20	ns
SDI Valid Setup Time from CNV Rising Edge	t <sub>SSDICNV</sub>	5			ns
SDI Valid Hold Time from CNV Rising Edge ( $\overline{\text{CS}}$ Mode)	t <sub>HSDICNV</sub>	10			ns
SDI Valid Hold Time from CNV Rising Edge (Chain Mode)	t <sub>HSDICNV</sub>	0			ns
SCK Valid Setup Time from CNV Rising Edge (Chain Mode)	t <sub>SSCKCNV</sub>	5			ns
SCK Valid Hold Time from CNV Rising Edge (Chain Mode)	t <sub>HSCCKCNV</sub>	5			ns
SDI Valid Setup Time from SCK Falling Edge (Chain Mode)	t <sub>SSDISCK</sub>	2			ns
SDI Valid Hold Time from SCK Falling Edge (Chain Mode)	t <sub>HSDISCK</sub>	3			ns
SDI High to SDO High (Chain Mode with Busy Indicator)	t <sub>DSDOSDI</sub>			22	ns

<sup>1</sup> Timing parameters measured with respect to a falling edge are defined as triggered at x% VIO. Timing parameters measured with respect to a rising edge are defined as triggered at y% VIO. For VIO ≤ 3 V, x = 90 and y = 10. For VIO > 3 V, x = 70 and y = 30. The minimum V<sub>IH</sub> and maximum V<sub>IL</sub> are used. See the Digital Inputs Specifications in Table 2.

<sup>2</sup> The time required to clock out N bits of data, t<sub>READ</sub>, may be greater than t<sub>ACQ</sub> depending on the magnitude of VIO. If t<sub>READ</sub> is greater than t<sub>ACQ</sub>, the throughput must be limited to ensure that all N bits are read back from the device.

## ABSOLUTE MAXIMUM RATINGS

Table 5.

Parameter	Rating
Analog Inputs	
IN+, IN- to GND <sup>1</sup>	-0.3 V to $V_{REF} + 0.3$ V or $\pm 130$ mA
Supply Voltage	
REF, VIO to GND	-0.3 V to +6.0 V
VDD to GND	-0.3 V to +3.0 V
VDD to VIO	-6 V to +3 V
Digital Inputs to GND	-0.3 V to VIO + 0.3 V
Digital Output to GND	-0.3 V to VIO + 0.3 V
Storage Temperature Range	-65°C to +150°C
Junction Temperature	150°C
Reflow Soldering	JEDEC Standard (J-STD-020)

<sup>1</sup> See the [Analog Inputs](#) section for an explanation of IN+ and IN-.

Stresses at or above those listed under Absolute Maximum Ratings may cause permanent damage to the product. This is a stress rating only; functional operation of the product at these or any other conditions above those indicated in the operational section of this specification is not implied. Operation beyond the maximum operating conditions for extended periods may affect product reliability.

## THERMAL RESISTANCE

Thermal performance is directly linked to printed circuit board (PCB) design and operating environment. Careful attention to PCB thermal design is required.

$\theta_{JA}$  is the natural convection junction to ambient thermal resistance measured in a one cubic foot sealed enclosure.  $\theta_{JC}$  is the junction to case thermal resistance.

Table 6. Thermal Resistance

Package Type <sup>1</sup>	$\theta_{JA}$	$\theta_{JC}$	Unit
RM-10	200	44	°C/W
CP-10-9	48.7	2.96	°C/W

<sup>1</sup> Test Condition 1: Thermal impedance simulated values are based on use of a 2S2P JEDEC PCB. See the [Ordering Guide](#) section.

## ESD CAUTION



**ESD (electrostatic discharge) sensitive device.** Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

## PIN CONFIGURATIONS AND FUNCTION DESCRIPTIONS

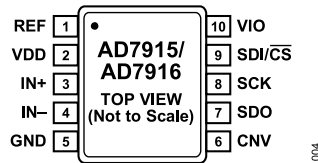
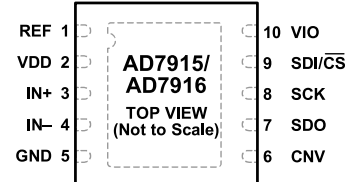


Figure 2. 10-Lead MSOP Pin Configuration



## NOTES

1. THE EXPOSED PAD CAN BE CONNECTED TO GND. THIS CONNECTION IS NOT REQUIRED TO MEET THE ELECTRICAL PERFORMANCES.

Figure 3. 10-Lead LFCSP Pin Configuration

Table 7. Pin Function Descriptions

Pin No.	Mnemonic	Type <sup>1</sup>	Description
1	REF	AI	Reference Input Voltage. The REF range is 2.4 V to 5.1 V. This pin is referred to the GND pin and must be decoupled closely to the GND pin with a 10 $\mu$ F capacitor.
2	VDD	P	Power Supply.
3	IN+	AI	Differential Positive Analog Input.
4	IN-	AI	Differential Negative Analog Input.
5	GND	P	Power Supply Ground.
6	CNV	DI	Conversion Input. This input has multiple functions. On its leading edge, CNV initiates the conversions and selects the interface mode of the device: chain mode or chip select ( $\overline{CS}$ ) mode. In $\overline{CS}$ mode, the SDO pin is enabled when CNV is low. In chain mode, the data is read when CNV is high.
7	SDO	DO	Serial Data Output. The conversion result is output on this pin. It is synchronized to SCK.
8	SCK	DI	Serial Data Clock Input. When the device is selected, the conversion result is shifted out by this clock.
9	SDI/ $\overline{CS}$	DI	Serial Data Input/Chip Select. This input has multiple functions. It selects the interface mode of the ADC as follows: Chain mode is selected if this pin is low during the CNV rising edge. In this mode, SDI/ $\overline{CS}$ is used as a data input to daisy-chain the conversion results of two or more ADCs onto a single SDO line. The digital data level on SDI/ $\overline{CS}$ is output on SDO with a delay of 16 SCK cycles. $\overline{CS}$ mode is selected if SDI/ $\overline{CS}$ is high during the CNV rising edge. In this mode, either SDI/ $\overline{CS}$ or CNV can enable the serial output signals when low.
10	VIO EP	P	Input/Output Interface Digital Power. This pin is nominally at the same supply as the host interface (1.8 V, 2.5 V, 3 V, or 5 V). Exposed Pad. For the lead frame chip scale package (LFCSP), the exposed pad can be connected to GND. This connection is not required to meet the electrical performances.

<sup>1</sup> AI is analog input, P is power, DI is digital input, and DO is digital output.



TYPICAL PERFORMANCE CHARACTERISTICS

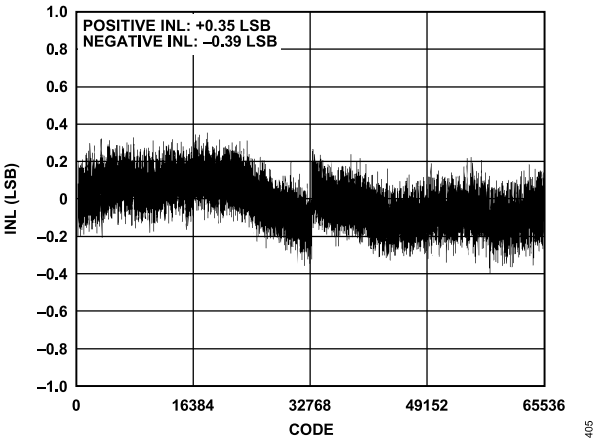


Figure 4. Integral Nonlinearity (INL) vs. Code, REF = 5 V

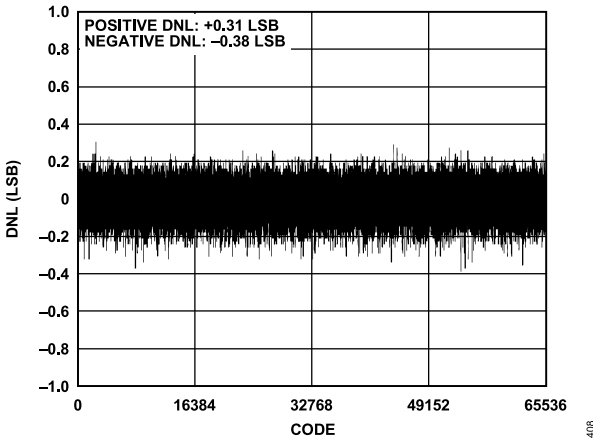


Figure 7. Differential Nonlinearity (DNL) vs. Code, REF = 5 V

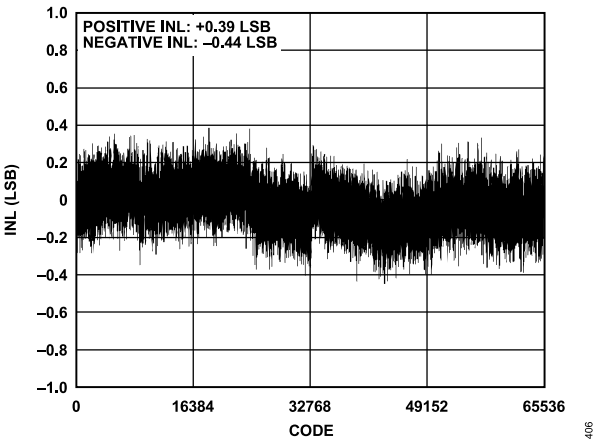


Figure 5. INL vs. Code, REF = 2.5 V

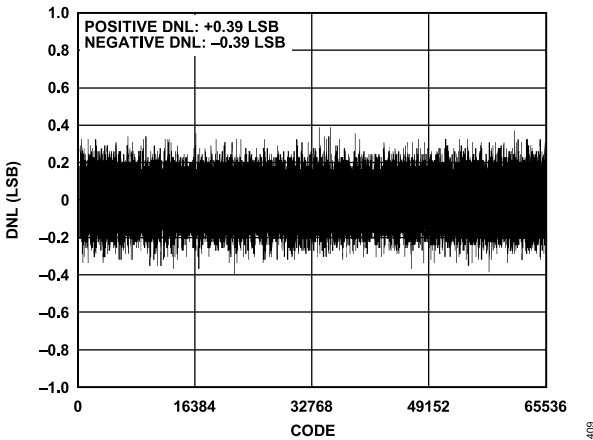


Figure 8. DNL vs. Code, REF = 2.5 V

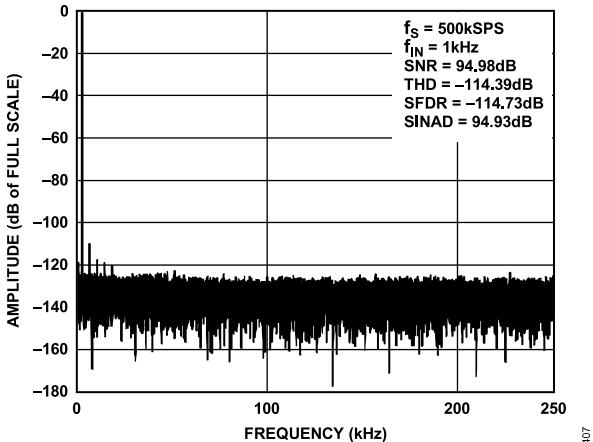


Figure 6. AD7916 FFT Plot, REF = 5 V

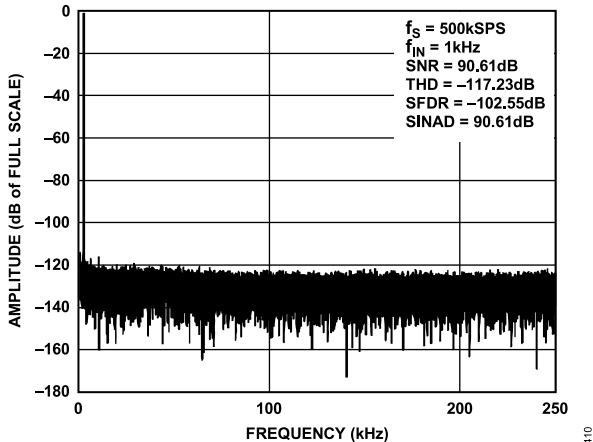


Figure 9. AD7916 FFT Plot, REF = 2.5 V

TYPICAL PERFORMANCE CHARACTERISTICS

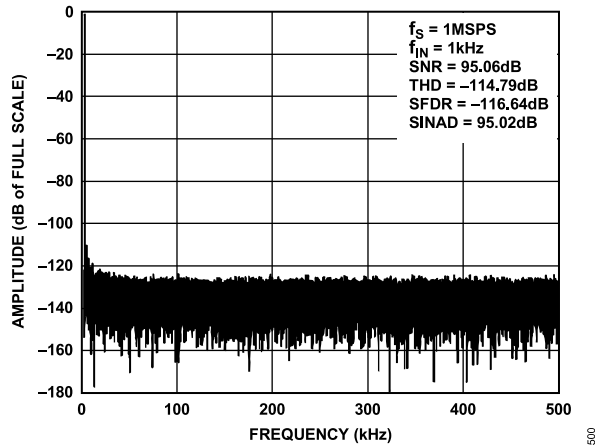


Figure 10. AD7915 FFT Plot, REF = 5 V

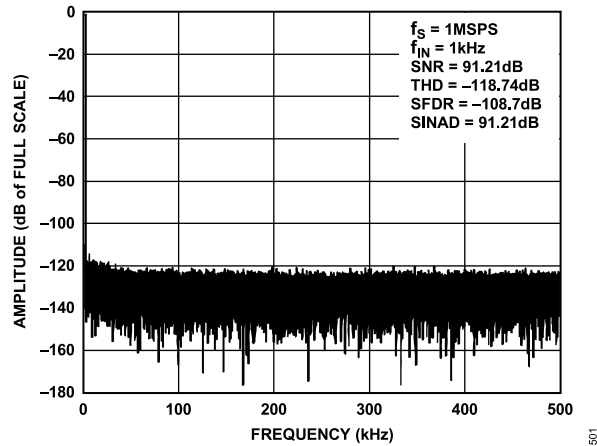


Figure 13. AD7915 FFT Plot, REF = 2.5 V

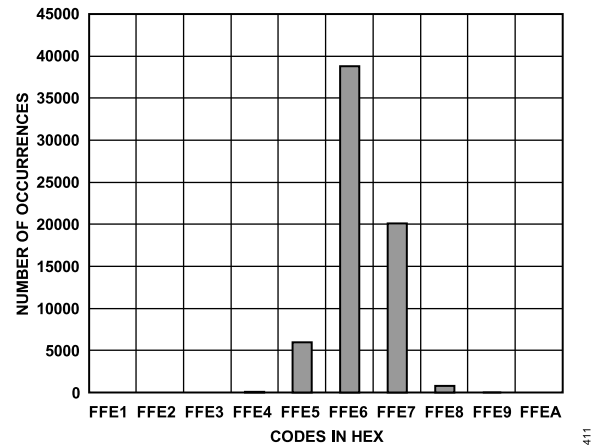


Figure 11. Histogram of a DC Input at the Code Center, REF = 5 V

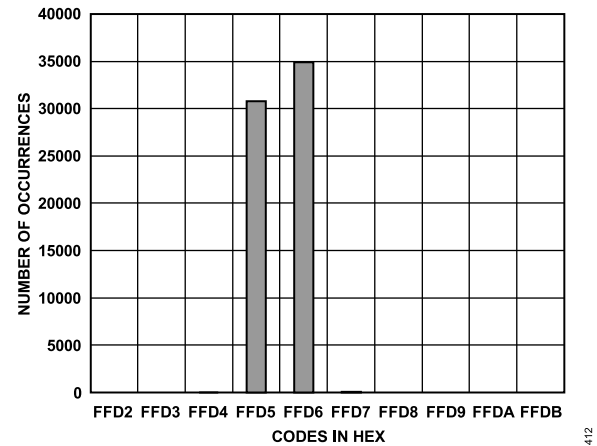


Figure 14. Histogram of a DC Input at the Code Transition, REF = 5 V

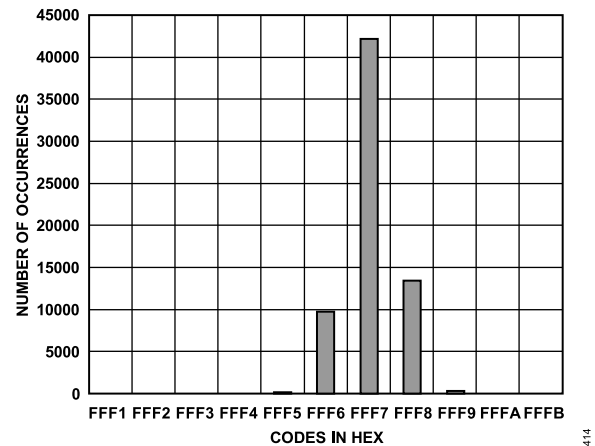


Figure 12. Histogram of a DC Input at the Code Center, REF = 2.5 V

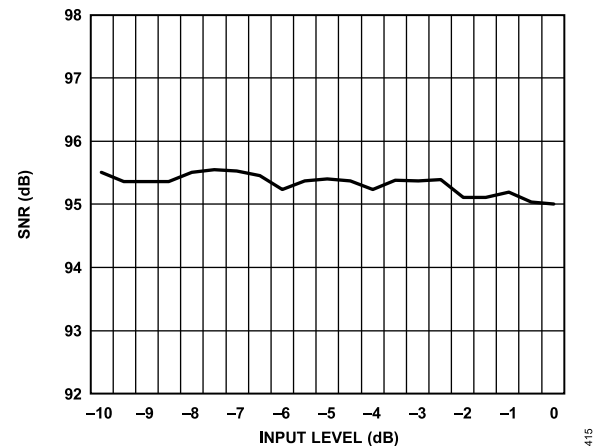


Figure 15. SNR vs. Input Level

## TYPICAL PERFORMANCE CHARACTERISTICS

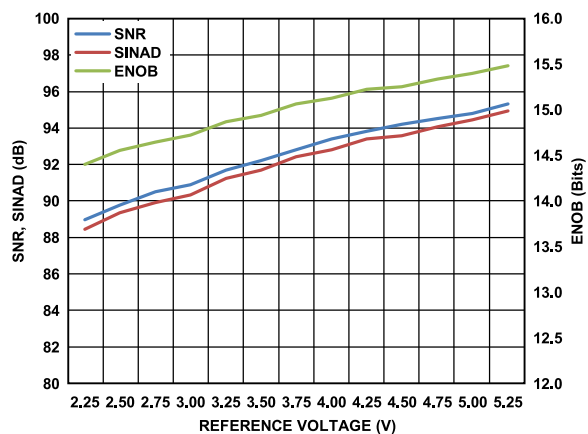


Figure 16. SNR, SINAD, and ENOB vs. Reference Voltage

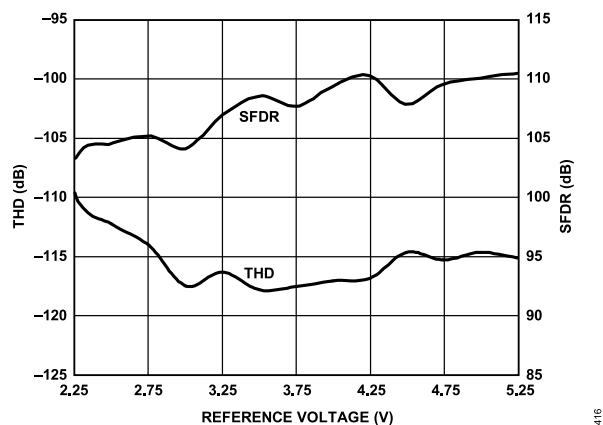


Figure 19. THD and SFDR vs. Reference Voltage

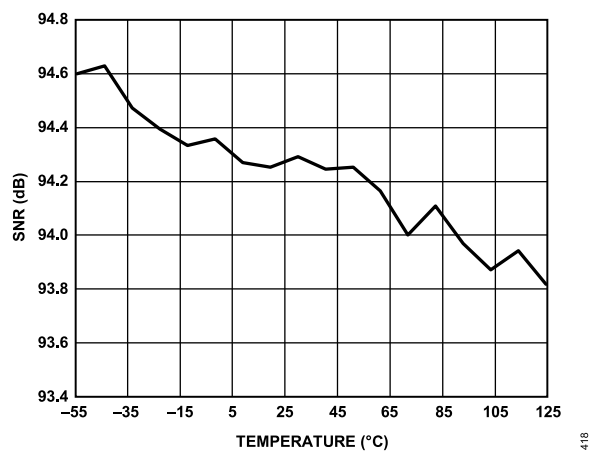


Figure 17. SNR vs. Temperature

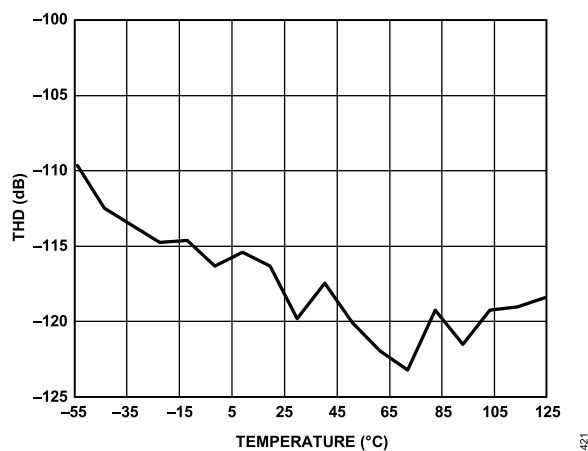


Figure 20. THD vs. Temperature

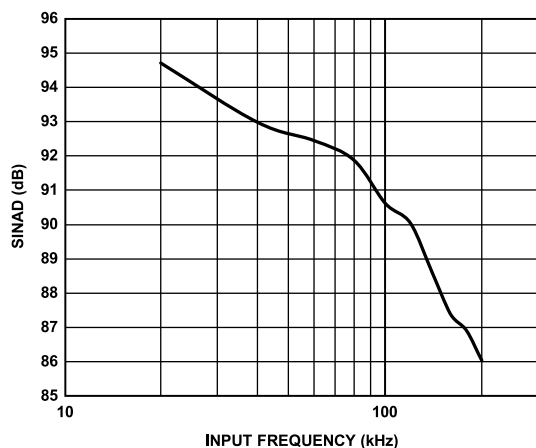


Figure 18. SINAD vs. Input Frequency

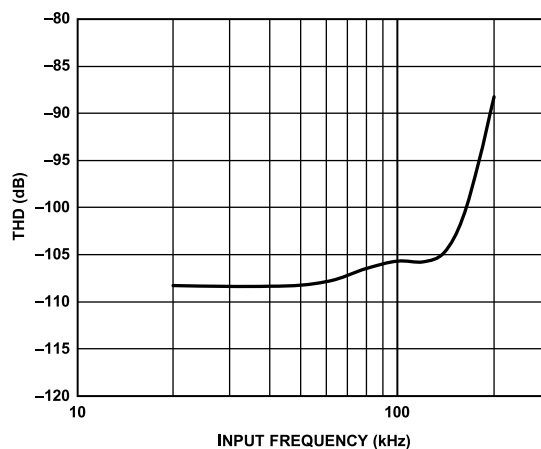


Figure 21. THD vs. Input Frequency

TYPICAL PERFORMANCE CHARACTERISTICS

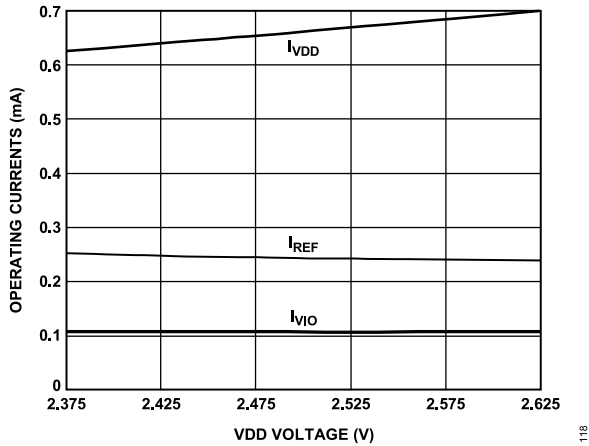


Figure 22. Operating Currents vs. VDD Voltage (AD7916)

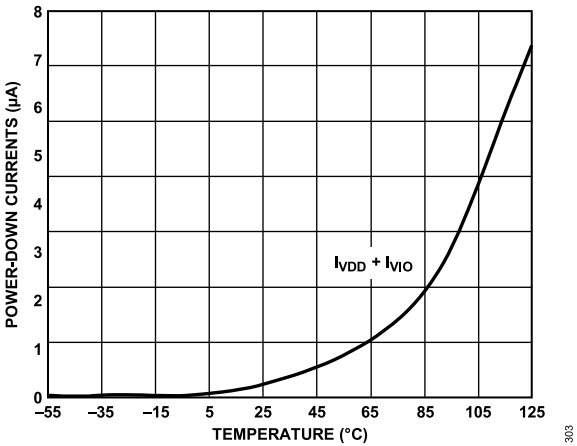


Figure 25. Power-Down Currents vs. Temperature

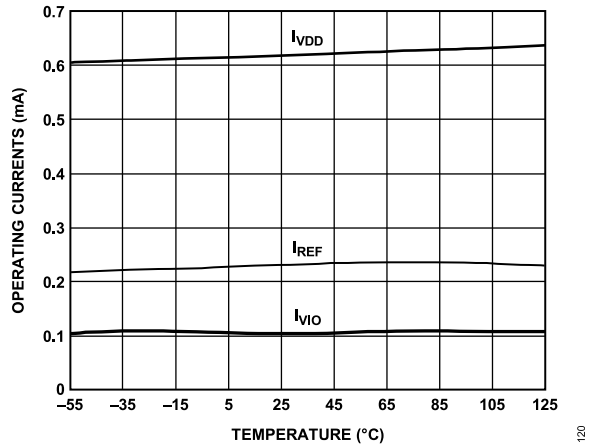


Figure 23. Operating Currents vs. Temperature (AD7916)

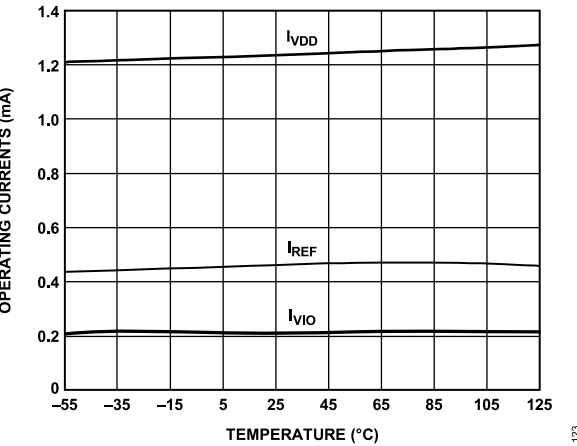


Figure 26. Operating Currents vs. Temperature (AD7915)

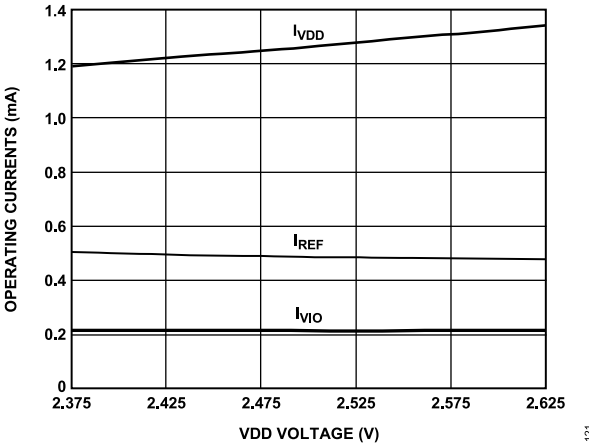


Figure 24. Operating Currents vs. VDD Voltage (AD7915)

## TERMINOLOGY

**Integral Nonlinearity Error (INL)**

INL refers to the deviation of each individual code from a line drawn from negative full scale through positive full scale. The point used as negative full scale occurs  $\frac{1}{2}$  LSB before the first code transition. Positive full scale is defined as a level  $1\frac{1}{2}$  LSB beyond the last code transition. The deviation is measured from the middle of each code to the true straight line (see [Figure 29](#)).

**Differential Nonlinearity Error (DNL)**

In an ideal ADC, code transitions are 1 LSB apart. DNL is the maximum deviation from this ideal value. It is often specified in terms of resolution for which no missing codes are guaranteed.

**Zero Error**

Zero error is the difference between the ideal midscale voltage, that is, 0 V, and the actual voltage producing the midscale output code, that is, 0 LSB.

**Gain Error**

The first transition (from 100 ... 00 to 100 ... 01) occurs at a level  $\frac{1}{2}$  LSB above nominal negative full scale ( $-4.999981$  V for the  $\pm 5$  V range). The last transition (from 011 ... 10 to 011 ... 11) occurs for an analog voltage  $1\frac{1}{2}$  LSB below the nominal full scale ( $+4.999943$  V for the  $\pm 5$  V range). The gain error is the deviation of the difference between the actual level of the last transition and the actual level of the first transition from the difference between the ideal levels.

**Spurious-Free Dynamic Range (SFDR)**

SFDR is the difference, in decibels (dB), between the rms amplitude of the input signal and the peak spurious signal.

**Effective Number of Bits (ENOB)**

ENOB is a measurement of the resolution with a sine wave input. It is related to SINAD as follows:

$$ENOB = (SINAD_{dB} - 1.76)/6.02$$

ENOB is expressed in bits.

**Noise-Free Code Resolution**

Noise-free code resolution is the number of bits beyond which it is impossible to distinctly resolve individual codes. It is calculated as

$$\text{Noise-Free Code Resolution} = \log_2(2^N / \text{Peak-to-Peak Noise})$$

and is expressed in bits.

**Effective Resolution**

Effective resolution is calculated as

$$\text{Effective Resolution} = \log_2(2^N / \text{RMS Input Noise})$$

and is expressed in bits.

**Total Harmonic Distortion (THD)**

THD is the ratio of the rms sum of the first five harmonic components to the rms value of a full-scale input signal and is expressed in decibels.

**Dynamic Range**

Dynamic range is the ratio of the rms value of the full scale to the total rms noise measured with the inputs shorted together. The value for dynamic range is expressed in decibels. It is measured with a signal at  $-60$  dB so that it includes all noise sources and DNL artifacts.

**Signal-to-Noise Ratio (SNR)**

SNR is the ratio of the rms value of the actual input signal to the rms sum of all other spectral components below the Nyquist frequency, excluding harmonics and dc. The value for SNR is expressed in decibels.

**Signal-to-Noise-and-Distortion Ratio (SINAD)**

SINAD is the ratio of the rms value of the actual input signal to the rms sum of all other spectral components that are less than the Nyquist frequency, including harmonics but excluding dc. The value of SINAD is expressed in decibels.

**Aperture Delay**

Aperture delay is the measure of the acquisition performance and is the time between the rising edge of the CNV input and when the input signal is held for a conversion.

**Transient Response**

Transient response is the time required for the ADC to accurately acquire its input after a full-scale step function is applied.

THEORY OF OPERATION

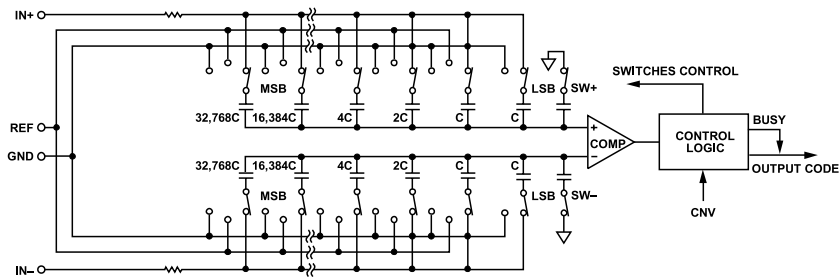


Figure 27. ADC Simplified Schematic

CIRCUIT INFORMATION

The AD7915/AD7916 are high speed, low power, single-supply, precise, 16-bit ADCs that use a successive approximation architecture.

The AD7916 can convert 500,000 samples per second (500 kSPS), whereas the AD7915 can convert 1,000,000 samples per second (1 MSPS); both devices power down between conversions. When operating at 1 MSPS, the AD7915 typically consumes 7 mW, making the ADC ideal for battery-powered applications.

The AD7915/AD7916 provide the user with an on-chip track-and-hold amplifier and do not exhibit any pipeline delay or latency, making these devices ideal for multiple multiplexed channel applications.

The AD7915/AD7916 can be interfaced to any 1.8 V to 5 V digital logic family. They are available in a 10-lead MSOP or a tiny 10-lead LFCSP that allows space savings and flexible configurations.

CONVERTER OPERATION

The AD7915/AD7916 are a successive approximation ADCs based on a charge redistribution digital-to-analog converter (DAC). Figure 27 shows the simplified schematic of the ADC. The capacitive DAC consists of two identical arrays of 18 binary-weighted capacitors, which are connected to the two comparator inputs.

During the acquisition phase, terminals of the array tied to the input of the comparator are connected to GND via SW+ and SW-. All independent switches are connected to the analog inputs. Therefore, the capacitor arrays are used as sampling capacitors and acquire the analog signal on the IN+ and IN- inputs. When the acquisition phase is complete and the CNV input goes high, a conversion phase is initiated.

When the conversion phase begins, SW+ and SW- are opened first. The two capacitor arrays are then disconnected from the inputs and connected to the GND input. Therefore, the differential voltage between the IN+ and IN- inputs captured at the end of the acquisition phase is applied to the comparator inputs, causing the comparator to become unbalanced. By switching each element of the capacitor array between GND and REF, the comparator input varies by binary-weighted voltage steps ( $V_{REF}/2$ ,  $V_{REF}/4$  ...  $V_{REF}/$

65,536). The control logic toggles these switches, starting with the MSB, to bring the comparator back into a balanced condition. After the completion of this process, the device returns to the acquisition phase, and the control logic generates the ADC output code.

Because the AD7915/AD7916 have an on-board conversion clock, the serial clock, SCK, is not required for the conversion process.

Transfer Functions

The ideal transfer characteristics for the AD7915/AD7916 are shown in Figure 28 and Table 8.

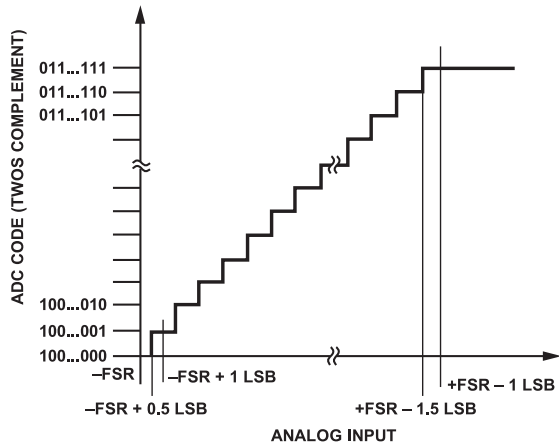


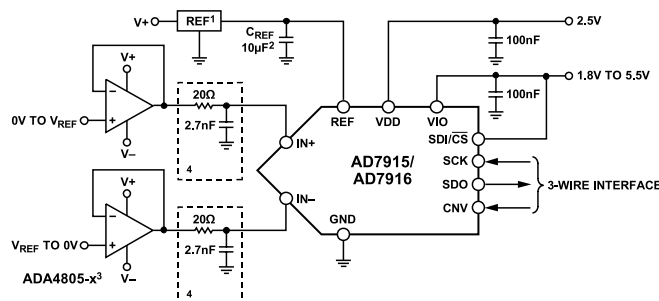
Figure 28. ADC Ideal Transfer Function

Table 8. Output Codes and Ideal Input Voltages		
Description	Analog Input $V_{REF} = 5\text{ V}$	Digital Output Code (Hex)
+FSR – 1 LSB	+4.999847 V	0x7FFF <sup>1</sup>
Midscale + 1 LSB	+152.6 $\mu\text{V}$	0x00001
Midscale	0 V	0x00000
Midscale – 1 LSB	–152.6 $\mu\text{V}$	0xFFFF
–FSR + 1 LSB	–4.999847 V	0x8001
–FSR	–5 V	0x8000 <sup>2</sup>

<sup>1</sup> This is also the code for an over-ranged analog input ( $V_{IN+} - V_{IN-}$  above  $V_{REF} - V_{GND}$ ).  
<sup>2</sup> This is also the code for an under-ranged analog input ( $V_{IN+} - V_{IN-}$  below  $V_{GND}$ ).

## THEORY OF OPERATION

## TYPICAL CONNECTION DIAGRAM



<sup>1</sup>SEE THE VOLTAGE REFERENCE INPUT SECTION FOR REFERENCE SELECTION.

<sup>2</sup>C<sub>REF</sub> IS USUALLY A 10µF CERAMIC CAPACITOR (X5R).

<sup>3</sup>SEE THE RECOMMENDED LAYOUT IN FIGURE 49 AND FIGURE 50.

<sup>4</sup>SEE THE DRIVER AMPLIFIER CHOICE SECTION.

<sup>5</sup>RECOMMENDED FILTER CONFIGURATION. SEE THE ANALOG INPUTS SECTION.

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Figure 29. Typical Application Diagram with Multiple Supplies

Figure 29 shows an example of the recommended connection diagram for the AD7915/AD7916 when multiple supplies are available.

## ANALOG INPUTS

Figure 30 shows an equivalent circuit of the input structure of the AD7915/AD7916.

The two diodes, D1 and D2, provide ESD protection for the analog inputs, IN+ and IN-. Care must be taken to ensure that the analog input signal does not exceed the reference input voltage (REF) by more than 0.3 V. If the analog input signal exceeds this level, the diodes become forward-biased and start conducting current. These diodes can handle a forward-biased current of 130 mA maximum. However, if the supplies of the input buffer (for example, the supplies of the ADA4805-1 or ADA4805-2, shown as ADA4805-x in Figure 29) are different from those of REF, the analog input signal may eventually exceed the supply rails by more than 0.3 V. In such a case (for example, an input buffer with a short circuit), the current limitation can be used to protect the device.

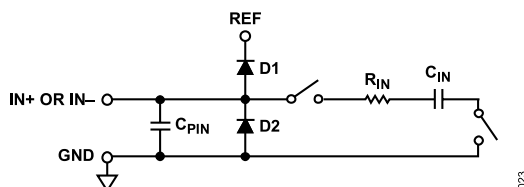


Figure 30. Equivalent Analog Input Circuit

The analog input structure allows the sampling of the true differential signal between IN+ and IN-. By using these differential inputs, signals common to both inputs are rejected.

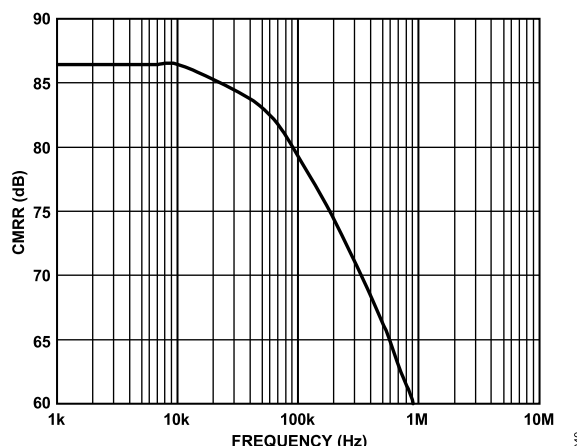


Figure 31. Analog Input CMRR vs. Frequency

During the acquisition phase, the impedance of the analog inputs (IN+ or IN-) can be modeled as a parallel combination of Capacitor C<sub>PIN</sub> and the network formed by the series connection of R<sub>IN</sub> and C<sub>IN</sub>. C<sub>PIN</sub> is primarily the pin capacitance. R<sub>IN</sub> is typically 400 Ω and is a lumped component composed of serial resistors and the on resistance of the switches. C<sub>IN</sub> is typically 30 pF and is mainly the ADC sampling capacitor.

During the sampling phase, when the switches are closed, the input impedance is limited to C<sub>PIN</sub>. R<sub>IN</sub> and C<sub>IN</sub> make a one-pole, low-pass filter that reduces undesirable aliasing effects and limits noise.

When the source impedance of the driving circuit is low, the AD7915/AD7916 can be driven directly. Large source impedance significantly affects the ac performance, especially THD. The dc performances are less sensitive to the input impedance. The maximum source impedance depends on the amount of THD that can be tolerated. The THD degrades as a function of the source impedance and the maximum input frequency.

## THEORY OF OPERATION

## DRIVER AMPLIFIER CHOICE

Although the AD7915/AD7916 are easy to drive, the driver amplifier must meet the following requirements:

- The noise generated by the driver amplifier must be kept as low as possible to preserve the SNR and transition noise performance of the AD7915/AD7916. The noise from the driver is filtered by the one-pole, low-pass filter of the AD7915/AD7916 analog input circuit made by  $R_{IN}$  and  $C_{IN}$  or by the external filter, if one is used. Because the typical noise of the AD7915/AD7916 is 60  $\mu$ V rms, the SNR degradation due to the amplifier is

$$SNR_{LOSS} = 20 \log \left( \frac{60}{\sqrt{60^2 + \frac{\pi}{2} f_{-3dB} (Ne_N)^2}} \right)$$

where:

$f_{-3dB}$  is the input bandwidth, in megahertz, of the AD7915/AD7916 (10 MHz) or the cutoff frequency of the input filter, if one is used.

$N$  is the noise gain of the amplifier (for example, 1 in buffer configuration).

$e_N$  is the equivalent input noise voltage of the op amp, in nV/ $\sqrt{\text{Hz}}$ .

- For ac applications, use a driver with a THD performance commensurate with the AD7915/AD7916.
- For multichannel, multiplexed applications, the driver amplifier and the AD7915/AD7916 analog input circuit must settle for a full-scale step onto the capacitor array at a 16-bit level (0.0015%, 15 ppm). In the data sheet of the amplifier, settling at 0.1% to 0.01% is more commonly specified. This settling may differ significantly from the settling time at a 16-bit level and must be verified prior to driver selection.

The [Precision ADC Driver Tool](#) can be used to model the settling behavior and to estimate the ac performance of the AD7915 with a selected driver and RC filter.

Table 9. Recommended Driver Amplifiers

Amplifier <sup>1</sup>	Typical Application
ADA4805-1/ADA4805-2	Low noise, small size, and low power
ADA4807-1/ADA4807-2	Very low noise and high frequency
ADA4841-1/ADA4841-2	Low noise, low distortion and low power
ADA4941-1	Very low noise, low power single-to-differential
ADA4945-1	Low noise, low distortion, fully differential
LTC6363	Low power, low noise, fully differential

<sup>1</sup> For the latest recommended drivers, see the product recommendations listed on the AD7915/AD7916 product webpage.

## SINGLE TO DIFFERENTIAL DRIVER

For applications using a single-ended analog signal, either bipolar or unipolar, the [ADA4941-1](#) single-ended to differential driver allows a differential input to the device. The schematic is shown in [Figure 32](#). The [ADA4940-1](#), which is a fully differential amplifier, can be used as a single-ended to-differential driver as well.

R1 and R2 set the attenuation ratio between the input range and the ADC range ( $V_{REF}$ ). R1, R2, and  $C_F$  are chosen depending on the desired input resistance, signal bandwidth, anti-aliasing, and noise contribution. For example, for the  $\pm 10$  V range with a 4 k $\Omega$  impedance, R2 = 1 k $\Omega$  and R1 = 4 k $\Omega$ .

R3 and R4 set the common mode on the IN $-$  input, and R5 and R6 set the common mode on the IN $+$  input of the ADC. Make sure that the common mode is close to  $V_{REF}/2$ . For example, for the  $\pm 10$  V range with a single supply, R3 = 8.45 k $\Omega$ , R4 = 11.8 k $\Omega$ , R5 = 10.5 k $\Omega$ , and R6 = 9.76 k $\Omega$ .

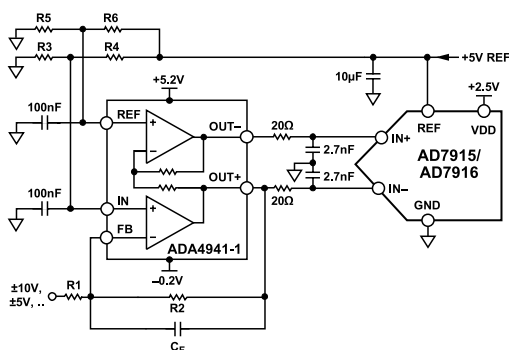


Figure 32. Single-Ended to Differential Driver Circuit



## THEORY OF OPERATION

### VOLTAGE REFERENCE INPUT

The AD7915/AD7916 voltage reference input, REF, has a dynamic input impedance and must, therefore, be driven by a low impedance source with efficient decoupling between the REF and GND pins, as explained in the [Layout](#) section.

When REF is driven by a very low impedance source (for example, a reference buffer using the [AD8031](#), [ADA4805-1](#) or the [ADA4807-1](#)), a 10  $\mu\text{F}$  (X5R, 0805 size) ceramic chip capacitor is appropriate for optimum performance.

If an unbuffered reference voltage is used, the decoupling value depends on the reference used. For instance, a 22  $\mu\text{F}$  (X5R, 1206 size) ceramic chip capacitor is appropriate for optimum performance using a low temperature drift reference, such as the [ADR435](#), [ADR445](#), [LTC6655](#), or [ADR4550](#).

If desired, a reference decoupling capacitor with values as small as 2.2  $\mu\text{F}$  can be used with a minimal impact on performance, especially DNL.

Regardless, there is no need for an additional lower value ceramic decoupling capacitor (for example, 100 nF) between the REF and GND pins.

### POWER SUPPLY

The AD7915/AD7916 use two power supply pins: a core supply (VDD) and a digital input/output interface supply (VIO). VIO allows direct interface with any logic between 1.8 V and 5.5 V. To reduce the number of supplies needed, VIO and VDD can be tied together. When VIO is greater than or equal to VDD, the AD7915/AD7916 are insensitive to power supply sequencing. In normal operation, if the magnitude of VIO is less than the magnitude of VDD, VIO must be applied before VDD. Additionally, they are insensitive to power supply variations over a wide frequency range, as shown in [Figure 33](#).

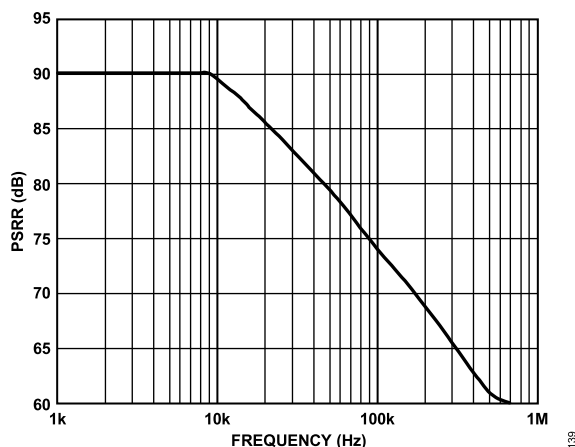


Figure 33. Power Supply Rejection Ratio (PSRR) vs. Frequency

The AD7915/AD7916 power down automatically at the end of each conversion phase.

### DIGITAL INTERFACE

Although the AD7915/AD7916 have a reduced number of pins, they offer flexibility in their serial interface modes.

When in  $\overline{\text{CS}}$  mode, the AD7915/AD7916 are compatible with SPI, QSPI™, MIRCROWIRE™, digital hosts, and DSPs. In this mode, the AD7915/AD7916 can use either a 3-wire or 4-wire interface. A 3-wire interface using the CNV, SCK, and SDO signals minimizes wiring connections, which is useful, for instance, in isolated applications. A 4-wire interface using the SDI/ $\overline{\text{CS}}$ , CNV, SCK, and SDO signals allows CNV, which initiates the conversions, to be independent of the readback timing (SDI). This is useful in low jitter sampling or simultaneous sampling applications.

When in chain mode, the AD7915/AD7916 provide a daisy-chain feature using the SDI input for cascading multiple ADCs on a single data line, similar to a shift register.

The mode in which the device operates depends on the SDI/ $\overline{\text{CS}}$  level when the CNV rising edge occurs.  $\overline{\text{CS}}$  mode is selected if SDI/ $\overline{\text{CS}}$  is high, and chain mode is selected if SDI/ $\overline{\text{CS}}$  is low. The SDI/ $\overline{\text{CS}}$  hold time is such that when SDI/ $\overline{\text{CS}}$  and CNV are connected together, chain mode is always selected. In either mode, the AD7915/AD7916 offers the option of forcing a start bit in front of the data bits. This start bit can be used as a busy signal indicator to interrupt the digital host and to trigger the data reading. Otherwise, without a busy indicator, the user must time out the maximum conversion time prior to read-back.

The busy indicator feature is enabled

- ▶ in  $\overline{\text{CS}}$  mode if CNV or SDI is low when the ADC conversion ends (see [Figure 37](#) and [Figure 41](#)).
- ▶ in chain mode if SCK is high during the CNV rising edge (see [Figure 45](#)).

## THEORY OF OPERATION

 **$\overline{\text{CS}}$  MODE, 3-WIRE, WITHOUT BUSY INDICATOR**

This mode is usually used when a single AD7915/AD7916 is connected to an SPI-compatible digital host. The connection diagram is shown in Figure 34, and the corresponding timing is given in Figure 35.

With  $\text{SDI}/\overline{\text{CS}}$  tied to VIO, a rising edge on CNV initiates a conversion, selects the  $\overline{\text{CS}}$  mode, and forces SDO to high impedance.

When the conversion is complete, the AD7915/AD7916 enter the acquisition phase and power down. When CNV goes low, the MSB is output onto SDO. The remaining data bits are clocked by subsequent SCK falling edges. The data is valid on both SCK edges. Although the rising edge can capture the data, a digital host using the SCK falling edge allows a faster reading rate, provided that it has an acceptable hold time. After the 16<sup>th</sup> SCK falling edge or when CNV goes high (whichever occurs first), SDO returns to high impedance.

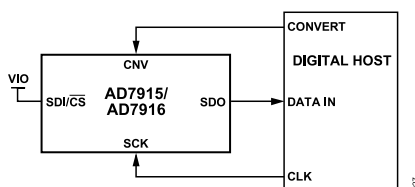


Figure 34.  $\overline{\text{CS}}$  Mode Without Busy Indicator, 3-Wire Connection Diagram (SDI High)

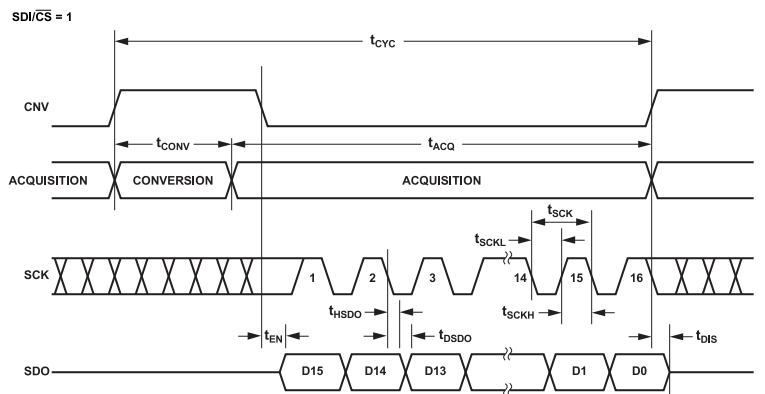


Figure 35.  $\overline{\text{CS}}$  Mode Without Busy Indicator, 3-Wire Serial Interface Timing (SDI High)

## THEORY OF OPERATION

 **$\overline{\text{CS}}$  MODE, 3-WIRE, WITH BUSY INDICATOR**

This mode is typically used when a single AD7915/AD7916 is connected to an SPI-compatible digital host having an interrupt input.

The connection diagram is shown in Figure 36, and the corresponding timing is given in Figure 37.

With SDI tied to VIO, a rising edge on CNV initiates a conversion, selects the  $\overline{\text{CS}}$  mode, and forces SDO to high impedance. SDO is maintained in high impedance until the completion of the conversion irrespective of the state of CNV. Prior to the minimum conversion time, CNV can select other SPI devices, such as analog multiplexers, but CNV must be returned low before the minimum conversion time elapses and then held low for the maximum conversion time to guarantee the generation of the busy signal indicator. When the conversion is complete, SDO goes from high impedance to low. With a pull-up on the SDO line, this transition can be used as an interrupt signal to initiate the data reading controlled by the digital host. The AD7915/AD7916 then enters the acquisition phase and powers down. The data bits are clocked out, MSB first, by subsequent SCK falling edges. The data is valid on both SCK edges. Although the rising edge can capture the data, a

digital host using the SCK falling edge allows a faster reading rate provided it has an acceptable hold time. After the optional 17<sup>th</sup> SCK falling edge, or when CNV goes high (whichever occurs first), SDO returns to high impedance.

If multiple AD7915/AD7916 devices are selected at the same time, the SDO output pin handles this contention without damage or induced latch-up. Meanwhile, it is recommended to keep this contention as short as possible to limit extra power dissipation.

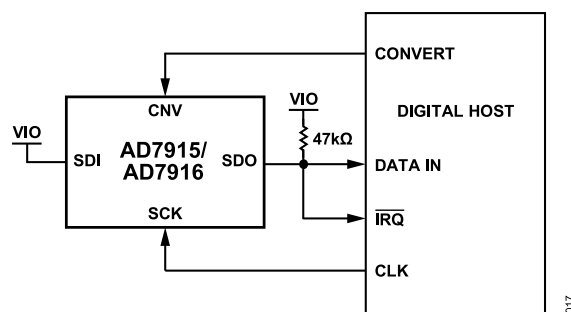


Figure 36. 3-Wire,  $\overline{\text{CS}}$  Mode with Busy Indicator Connection Diagram (SDI High)

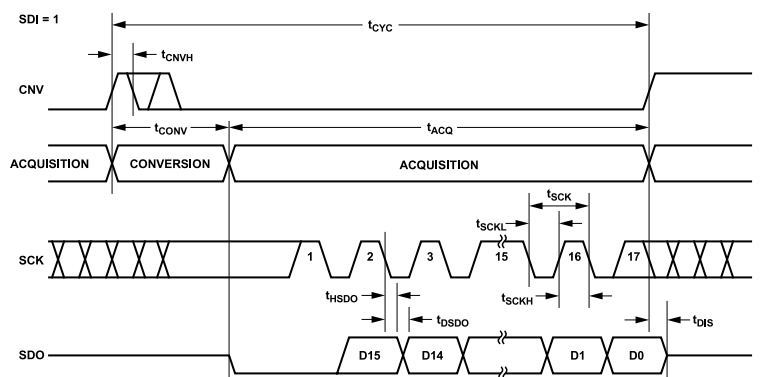


Figure 37. 3-Wire,  $\overline{\text{CS}}$  Mode with Busy Indicator Serial Interface Timing (SDI High)

## THEORY OF OPERATION

 **$\overline{\text{CS}}$  MODE, 4-WIRE, WITHOUT BUSY INDICATOR**

This mode is usually used when multiple AD7915/AD7916 devices are connected to an SPI-compatible digital host.

A connection diagram example using two AD7915/AD7916 devices is shown in Figure 38, and the corresponding timing is given in Figure 39.

With SDI high, a rising edge on CNV initiates a conversion, selects  $\overline{\text{SDI}}/\overline{\text{CS}}$  mode, and forces SDO to high impedance. In this mode, CNV must be held high during the conversion phase and the subsequent data read back; if  $\overline{\text{SDI}}/\overline{\text{CS}}$  and CNV are low, SDO is driven low. Prior to the minimum conversion time,  $\overline{\text{SDI}}/\overline{\text{CS}}$  can be

used to select other SPI devices, such as analog multiplexers, but  $\overline{\text{SDI}}/\overline{\text{CS}}$  must be returned high before the minimum conversion time elapses and then held high for the maximum possible conversion time. When the conversion is complete, the AD7915/AD7916 enter the acquisition phase and power down. Each ADC result can be read by bringing its  $\overline{\text{SDI}}/\overline{\text{CS}}$  input low, which consequently outputs the MSB onto SDO. The remaining data bits are then clocked by subsequent SCK falling edges. The data is valid on both SCK edges. Although the rising edge can be used to capture the data, a digital host using the SCK falling edge allows a faster reading rate, provided that it has an acceptable hold time. After the 16<sup>th</sup> SCK falling edge or when  $\overline{\text{SDI}}/\overline{\text{CS}}$  goes high (whichever occurs first), SDO returns to high impedance and another AD7915/AD7916 can be read.

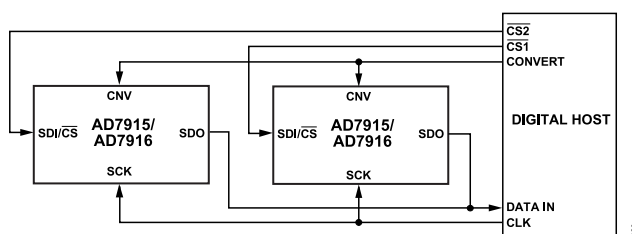


Figure 38.  $\overline{\text{CS}}$  Mode Without Busy Indicator, 4-Wire Connection Diagram

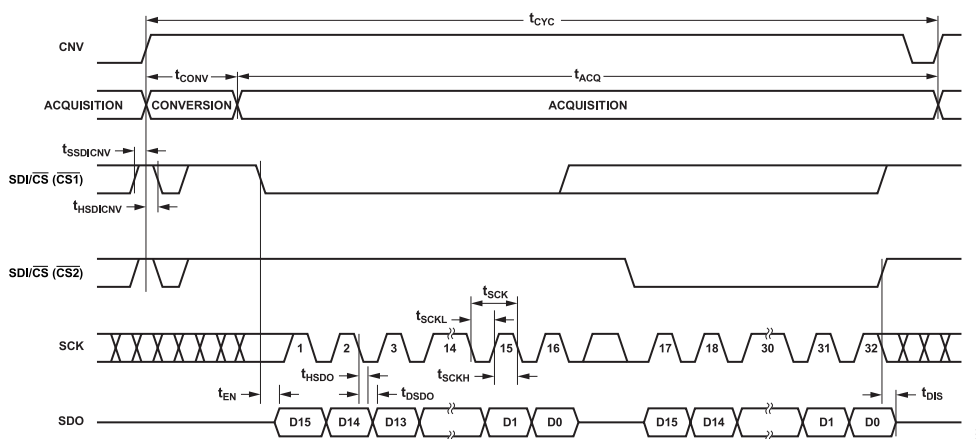


Figure 39.  $\overline{\text{CS}}$  Mode Without Busy Indicator, 4-Wire Serial Interface Timing

## THEORY OF OPERATION

 **$\overline{\text{CS}}$  MODE, 4-WIRE, WITH BUSY INDICATOR**

This mode is usually used when a single AD7915/AD7916 is connected to an SPI-compatible digital host that has an interrupt input, and it is desired to keep CNV, which is used to sample the analog input, independent of the signal used to select the data reading. This requirement is particularly important in applications where low jitter on CNV is desired.

The connection diagram is shown in Figure 40, and the corresponding timing is given in Figure 41.

With SDI high, a rising edge on CNV initiates a conversion, selects the  $\overline{\text{CS}}$  mode, and forces SDO to high impedance. In this mode, CNV must be held high during the conversion phase and the subsequent data read-back (if SDI and CNV are low, SDO is driven low). Prior to the minimum conversion time, SDI can be used to select other SPI devices, such as analog multiplexers, but SDI must be returned low before the minimum conversion time elapses and then held low for the maximum conversion time to guarantee the generation of the busy signal indicator. When the conversion is complete, SDO goes from high impedance to low.

With a pull-up on the SDO line, this transition can be used as an interrupt signal to initiate the data read-back controlled by the

digital host. The AD7915/AD7916 then enters the acquisition phase and powers down. The data bits are clocked out, MSB first, by subsequent SCK falling edges. The data is valid on both SCK edges. Although the rising edge can be used to capture the data, a digital host using the SCK falling edge allows a faster reading rate provided it has an acceptable hold time. After the optional 17th SCK falling edge or SDI going high, whichever is earlier, the SDO returns to high impedance.

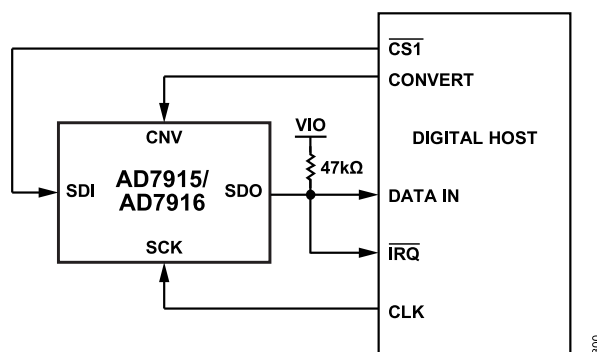


Figure 40. 4-Wire,  $\overline{\text{CS}}$  Mode with Busy Indicator Connection Diagram

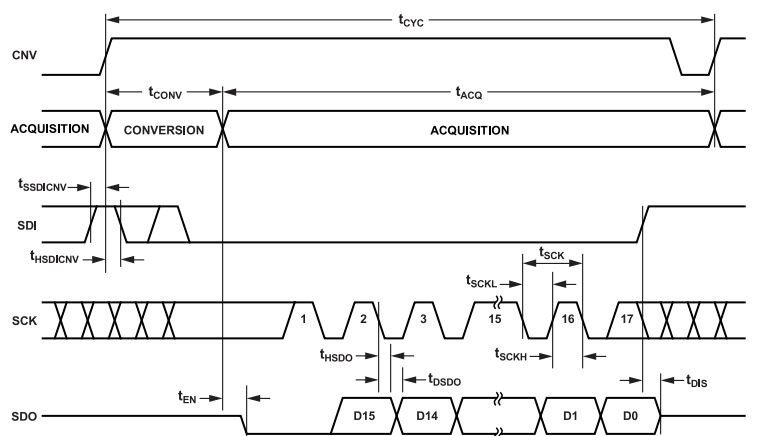


Figure 41. 4-Wire,  $\overline{\text{CS}}$  Mode with Busy Indicator Serial Interface Timing

## THEORY OF OPERATION

## CHAIN MODE, WITHOUT BUSY INDICATOR

This mode can be used to daisy-chain multiple AD7915/AD7916 devices on a 3-wire serial interface. This feature is useful for reducing component count and wiring connections, for example, in isolated multi-converter applications or for systems with a limited interfacing capacity. Data read-back is analogous to clocking a shift register.

A connection diagram example using two AD7915/AD7916 devices is shown in Figure 42, and the corresponding timing is given in Figure 43.

When  $\text{SDI}/\overline{\text{CS}}$  and CNV are low, SDO is driven low. With SCK low, a rising edge on CNV initiates a conversion, and selects the chain mode. In this mode, CNV is held high during the conversion

phase and the subsequent data read-back. When the conversion is complete, the MSB is output onto SDO and the AD7915/AD7916 enter the acquisition phase and power down. The remaining data bits stored in the internal shift register are clocked by subsequent SCK falling edges. For each ADC, SDI feeds the input of the internal shift register and is clocked by the SCK falling edge. Each ADC in the chain outputs its data MSB first, and  $16 \times N$  clocks are required to read back the  $N$  ADCs. The data is valid on both SCK edges. Although the rising edge can be used to capture the data, a digital host using the SCK falling edge allows a faster reading rate and, consequently, more AD7915/AD7916 devices in the chain, provided that the digital host has an acceptable hold time. The maximum conversion rate may be reduced due to the total read-back time.

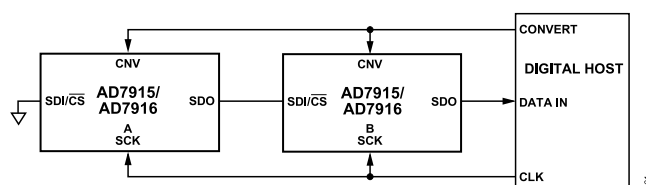


Figure 42. Chain Mode Without Busy Indicator Connection Diagram

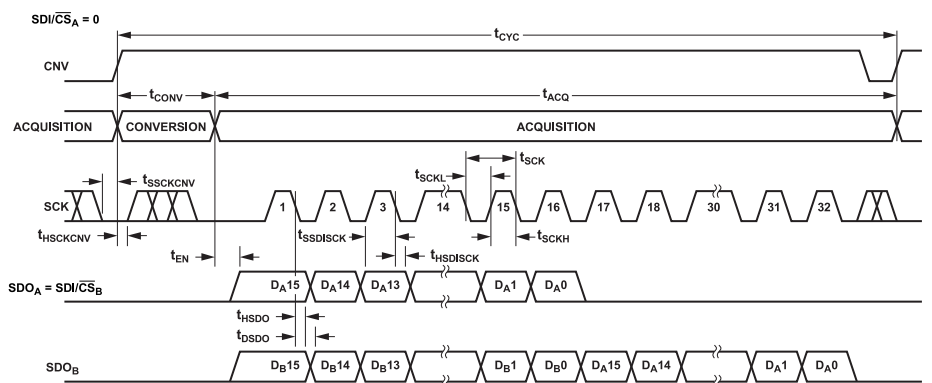


Figure 43. Chain Mode Without Busy Indicator Serial Interface Timing





## APPLICATIONS INFORMATION

## INTERFACING TO BLACKFIN DSP

The AD7915/AD7916 can easily connect to a Blackfin® DSP SPI or SPORT. The SPI configuration is straightforward using the standard SPI interface, as shown in Figure 46.

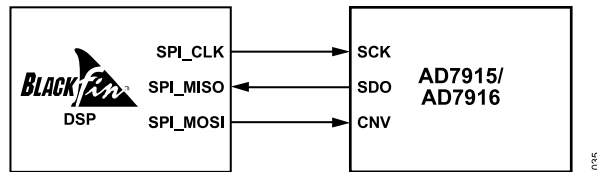


Figure 46. Typical Connection to Blackfin SPI Interface

Similarly, the SPORT interface can be used to interface to this ADC. The SPORT interface has some benefits in that it can use direct memory access (DMA) and provides a lower jitter CNV signal generated from a hardware counter.

Some glue logic may be required between SPORT and the AD7915/AD7916 interface. The evaluation board for the AD7915/AD7916 interfaces directly to the SPORT of the Blackfin-based (ADSP-BF527) SDP board. The configuration used for the SPORT interface requires the addition of some glue logic as shown in Figure 47. The SCK input to the ADC was gated off when CNV was high to keep the SCK line static while converting the data, thereby ensuring the best integrity of the result. This approach uses an AND gate and a NOT gate for the SCK path. The other logic gates used on the RCLK and RFS paths are for delay matching purposes and may not be necessary when path lengths are short.

This is one approach to using the SPORT interface for this ADC; there may be other solutions similar to this approach.

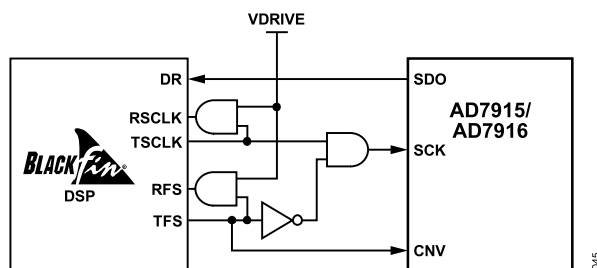


Figure 47. Evaluation Board Connection to Blackfin Sport Interface

## LAYOUT

Design the printed circuit board that houses the AD7915/AD7916 so that the analog and digital sections are separated and confined to certain areas of the board. The pinout of the AD7915/AD7916, with its analog signals on the left side and its digital signals on the right side, eases this task.

Avoid running digital lines under the device because these couple noise onto the die, unless a ground plane under the AD7915/AD7916 is used as a shield. Do not run fast switching signals, such as CNV or clocks, near analog signal paths. Avoid crossover of digital and analog signals.

Using at least one ground plane is recommended. The ground plane can be common or split between the digital and analog sections. In the latter case, join the planes underneath the AD7915/AD7916 devices.

The AD7915/AD7916 voltage reference input, REF, has a dynamic input impedance. Decouple REF with minimal parasitic inductance by placing the reference decoupling ceramic capacitor close to, but ideally right up against, the REF and GND pins and connecting them with wide, low impedance traces.

Finally, decouple the power supplies of the AD7915/AD7916, VDD and VIO, with ceramic capacitors, typically 100 nF, placed close to the AD7915/AD7916 and connected using short, wide traces to provide low impedance paths and to reduce the effect of glitches on the power supply lines.

An example of a layout following these rules is shown in Figure 48 and Figure 49.

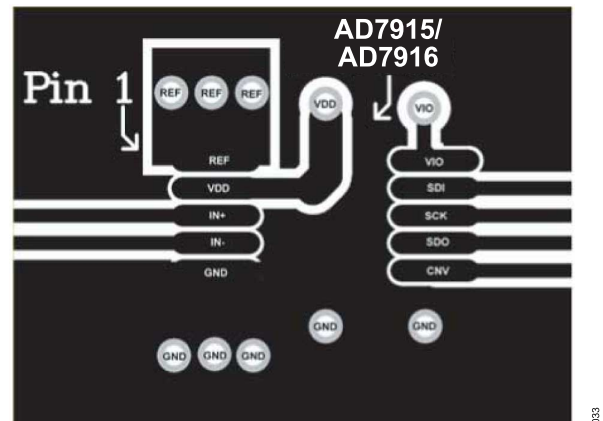


Figure 48. Recommended Layout of the AD7915/AD7916 (Top Layer)

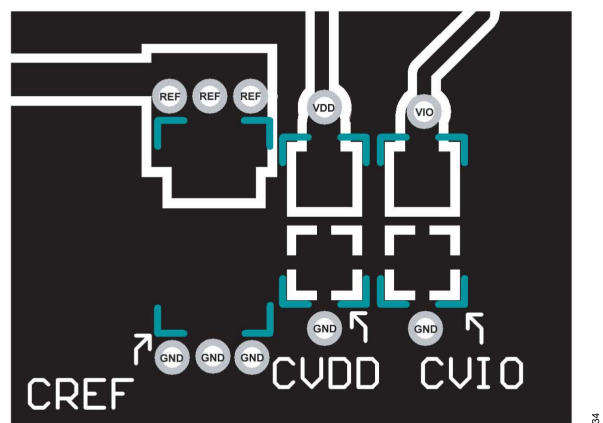


Figure 49. Recommended Layout of the AD7915/AD7916 (Bottom Layer)

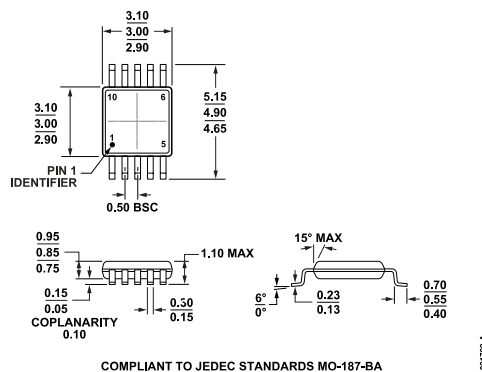


## APPLICATIONS INFORMATION

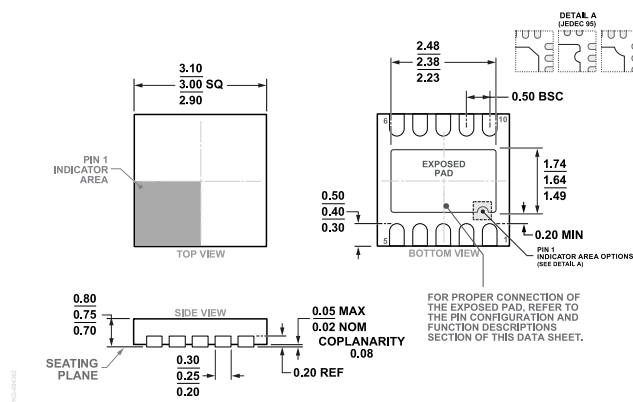
### EVALUATING AD7915/AD7916 PERFORMANCE

Other recommended layouts for the AD7915/AD7916 are outlined in [UG-340](#), the user guide of the evaluation board for the AD7915/AD7916 ([EVAL-AD7915SDZ/EVAL-AD7916SDZ](#)). The evaluation board package includes a fully assembled and tested evaluation board, the user guide, and software for controlling the board from a PC via the [EVAL-SDP-CB1Z](#).

## OUTLINE DIMENSIONS



**Figure 50. 10-Lead Mini Small Outline Package [MSOP]  
(RM-10)**  
Dimensions shown in millimeters



**Figure 51. 10-Lead Lead Frame Chip Scale Package [LFCSP]  
3 mm × 3 mm Body and 0.75 mm Package Height  
(CP-10-9)**  
Dimensions shown in millimeters

Updated: March 20, 2023

## ORDERING GUIDE

Model <sup>1</sup>	Temperature Range	Package Description	Packing Quantity	Package Option	Marking Code
AD7915BCPZ-RL7	-40°C to +125°C	10-Lead LFCSP (3mm x 3mm)	Reel, 1500	CP-10-9	C87
AD7915BRMZ	-40°C to +125°C	10-Lead MSOP		RM-10	C85
AD7915BRMZ-RL7	-40°C to +125°C	10-Lead MSOP	Reel, 1000	RM-10	C85
AD7916BCPZ-RL7	-40°C to +125°C	10-Lead LFCSP (3mm x 3mm)	Reel, 1500	CP-10-9	C88
AD7916BRMZ	-40°C to +125°C	10-Lead MSOP		RM-10	C86
AD7916BRMZ-RL7	-40°C to +125°C	10-Lead MSOP	Reel, 1000	RM-10	C86

<sup>1</sup> Z = RoHS Compliant Part.

## OUTLINE DIMENSIONS

## EVALUATION BOARDS

Model <sup>1, 2, 3</sup>	Description
EVAL-AD7915SDZ	Evaluation Board
EVAL-AD7916SDZ	Evaluation Board
EVAL-SDP-CB1Z	System Demonstration Board, Used as a Controller Board for Data Transfer via a USB Interface to PC

<sup>1</sup> Z = RoHS Compliant Part.

<sup>2</sup> The [EVAL-AD7915SDZ](#) and [EVAL-AD7916SDZ](#) boards can be used as standalone evaluation boards, or in conjunction with the [EVAL-SDP-CB1Z](#) for evaluation and demonstration purposes.

<sup>3</sup> The EVAL-SDP-CB1Z board allows a PC to control and communicate with all Analog Devices, Inc., evaluation boards ending in the SD designator.

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[EVAL-AD7916SDZ](#) [EVAL-AD7915SDZ](#)